

**PATENT ASSIGNMENT**

Electronic Version v1.1  
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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT												
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT												
<b>CONVEYING PARTY DATA</b>													
<table border="1" style="width: 100%; border-collapse: collapse;"><thead><tr><th style="width: 70%;">Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Seiichiro KANNO</td><td>07/19/2011</td></tr><tr><td>Hiroyuki KITSUNAI</td><td>07/19/2011</td></tr><tr><td>Masaru MATSUSHIMA</td><td>07/25/2011</td></tr><tr><td>Toru SHUTO</td><td>07/20/2011</td></tr><tr><td>Kazuyuki IKENAGA</td><td>07/26/2011</td></tr></tbody></table>		Name	Execution Date	Seiichiro KANNO	07/19/2011	Hiroyuki KITSUNAI	07/19/2011	Masaru MATSUSHIMA	07/25/2011	Toru SHUTO	07/20/2011	Kazuyuki IKENAGA	07/26/2011
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<b>RECEIVING PARTY DATA</b>													
<b>Name:</b>	HITACHI HIGH-TECHNOLOGIES CORPORATION												
<b>Street Address:</b>	24-14, Nishi-Shimbashi 1-chome, Minato-ku,												
<b>City:</b>	Tokyo												
<b>State/Country:</b>	JAPAN												
<b>PROPERTY NUMBERS Total: 1</b>													
<table border="1" style="width: 100%; border-collapse: collapse;"><thead><tr><th style="width: 30%;">Property Type</th><th>Number</th></tr></thead><tbody><tr><td><b>Application Number:</b></td><td>13202556</td></tr></tbody></table>		Property Type	Number	<b>Application Number:</b>	13202556								
Property Type	Number												
<b>Application Number:</b>	13202556												
<b>CORRESPONDENCE DATA</b>													
<b>Fax Number:</b>	(202)756-8087												
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<b>ATTORNEY DOCKET NUMBER:</b>	062807-0737												
<b>NAME OF SUBMITTER:</b>	Keith E. George												
<b>Total Attachments: 2</b> source=0628070737assigntransmittal#page1.tif source=0628070737assign#page1.tif													

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RECORDATION FORM COVER SHEET

**Docket No.: 062807-0737**

**PATENTS ONLY**

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

**1. Name of Conveying Party(ies)**  
 Seiichiro KANNO, Hiroyuki KITSUNAI, Masaru MATSUSHIMA, Toru SHUTO, Kazuyuki IKENAGA

Additional name(s) of conveying party(ies) attached?  Yes  No

**2. Name and address of receiving party(ies)**  
 Name: **HITACHI HIGH-TECHNOLOGIES CORPORATION**  
 Internal Address:  
 Address: **24-14, Nishi-Shimbashi 1-chome, Minato-ku, Tokyo, Japan**

**3. Nature of Conveyance/Execution Date(s)**

Execution Date(s): **July 19, 2011; July 19, 2011; July 25, 2011; July 20, 2011 and July 26, 2011 respectively**

Assignment  Merger  
 Security Agreement  Change of Name  
 Joint Research Agreement  
 Government Interest Assignment  
 Executive Order 9424, Confirmatory License

**4. Application or patent number(s):**  
 A. Patent Application No(s).

**5. Name and address to whom correspondence concerning document should be mailed:**

This document is being filed together with a new application.  
 B. Patent No(s).

**6. Total number of applications and patents involved:**

Name: **MCDERMOTT WILL & EMERY LLP**  
 Internal Address:  
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 Fax Number: **202.756.8087**  
 Email Address:

**7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00**

Authorized to be charged by credit card  
 Authorized to be charged to deposit account  
 Enclosed  
 None required (government interest not affecting title)

**8. Payment Information:**

a. Credit Card Last 4 Numbers \_\_\_\_\_  
 Expiration Date \_\_\_\_\_

b. Deposit Account Number 500417  
 Authorized User Name \_\_\_\_\_

**9. Signature.**  
**Keith E. George 34,111**

*Keith E. George* **August 19, 2011**

Name and Registration No. of Person Signing \_\_\_\_\_ Signature \_\_\_\_\_ Date \_\_\_\_\_

Total number of pages including cover sheet, attachments and documents: **2**

ASSIGNMENT  
(讓渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI HIGH-TECHNOLOGIES CORPORATION, a corporation organized under the laws of Japan, located at 24-14, Nishi-Shimbashi 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI HIGH-TECHNOLOGIES CORPORATION, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

ELECTRON MICROSCOPE, AND SPECIMEN HOLDING METHOD

\* PCT International Application Number PCT/JP2009/005375 filed on October 15, 2009

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI HIGH-TECHNOLOGIES CORPORATION, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI HIGH-TECHNOLOGIES CORPORATION.

Signed on the date(s) indicated aside signatures:

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1)	<u>Seiichiro Kanno</u> Seiichiro KANNO	<u>7/19/2011</u>
2)	<u>Hiroyuki Kitsunai</u> Hiroyuki KITSUNAI	<u>7/19/2011</u>
3)	<u>Masaru Matsushima</u> Masaru MATSUSHIMA	<u>7/25/2011</u>
4)	<u>Toru Shuto</u> Toru SHUTO	<u>7/20/2011</u>
5)	<u>Kazuyuki Ikenaga</u> Kazuyuki IKENAGA	<u>7/26/2011</u>
6)	_____	_____
7)	_____	_____
8)	_____	_____
9)	_____	_____
10)	_____	_____

PATENT